Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	· · · · · · · · · · · · · · · · · · ·			, ,,		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$	30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		34		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 6		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1.2		2.5	٧
Gate Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			10	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	20			Α
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 7 A		0.0122	0.015	Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		0.0138	0.017	
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 7 A		40		S
Dynamic ^a						
Input Capacitance	C _{iss}	N-Channel V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		1750		pF
Output Capacitance	C _{oss}			265		
Reverse Transfer Capacitance	C _{rss}			115		
tal Cata Chargo		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		32	48	nC
Total Gate Charge	Q_g	N Observed		14.7	22	
Gate-Source Charge	Q_{gs}	N-Channel $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$		5.1		
Gate-Drain Charge	Q_{gd}			3.7		
Gate Resistance	R_g	f = 1 MHz	0.2	1.0	2.0	Ω
Turn-On Delay Time	t _{d(on)}	N-Channel $V_{DD} = 15 \text{ V, R}_L = 3 \Omega$ $I_D \cong 5 \text{ A, V}_{GEN} = 4.5 \text{ V, R}_g = 1 \Omega$		21	40	ns
Rise Time	t _r			10	20	
Turn-Off Delay Time	t _{d(off)}			26	50	
Fall Time	t _f			8	16	
Turn-On Delay Time	t _{d(on)}	N-Channel $V_{DD} = 15 \text{ V, R}_L = 3 \Omega$ $I_D \cong 5 \text{ A, V}_{GEN} = 10 \text{ V, R}_g = 1 \Omega$		9	18	
Rise Time	t _r			8	16	
Turn-Off Delay Time	t _{d(off)}			24	45	
Fall Time	t _f			8	16	
Drain-Source Body Diode Characterist	cs					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.6	A
Pulse Diode Forward Current ^a	I _{SM}				30	
Body Diode Voltage	V _{SD}	I _S = 2 A		0.75	1.2	٧
Body Diode Reverse Recovery Time	t _{rr}	N-Channel I _F = 5 A, dl/dt = 100 A/μs, T _J = 25 °C		23	45	ns
Body Diode Reverse Recovery Charge	Q_{rr}			16	32	nC
Reverse Recovery Fall Time	t _a			13		ns
Reverse Recovery Rise Time	t _b			10		

Notes:

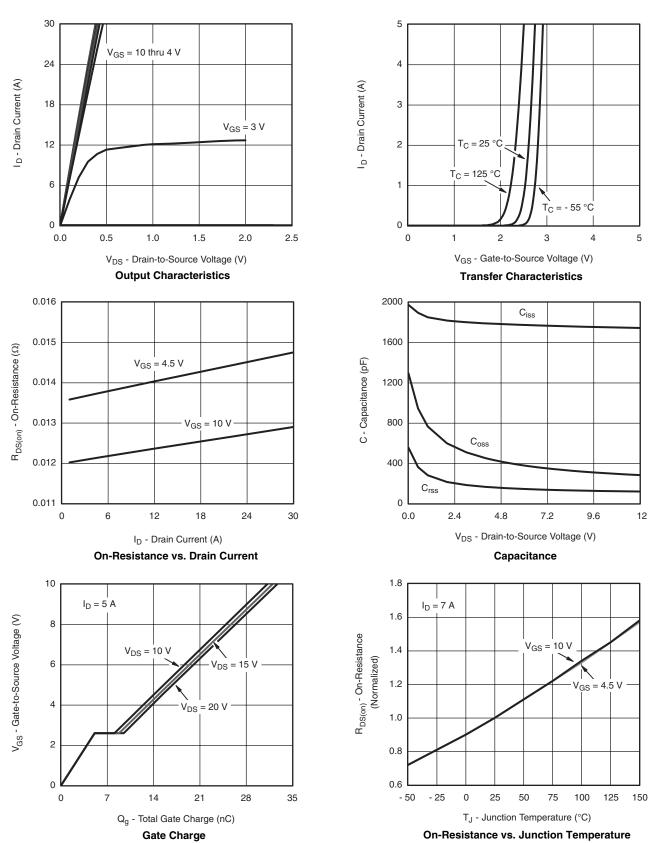
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



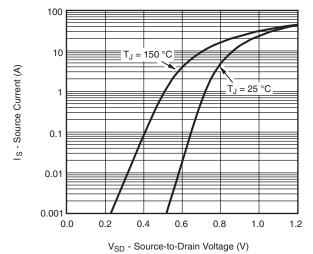


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

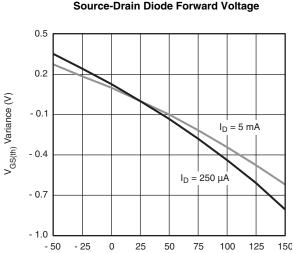


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Source-Drain Diode Forward Voltage

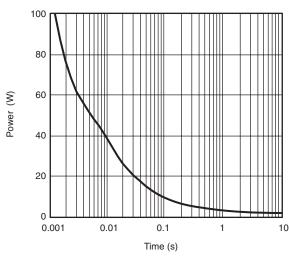


T_J - Temperature (°C)

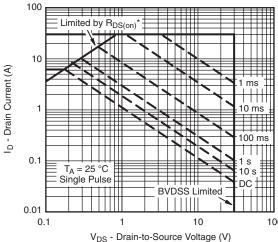
Threshold Voltage

0.05 $I_D = 7 A$ 0.04 $R_{DS(on)}$ - On-Resistance (Ω) 0.03 T_J = 125 °C 0.02 0.01 T_J = 25 °C 0.00 0 2 3 4 5 10 V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

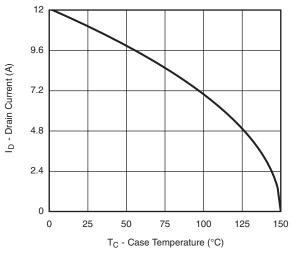


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

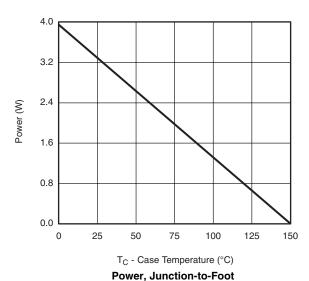
Safe Operating Area

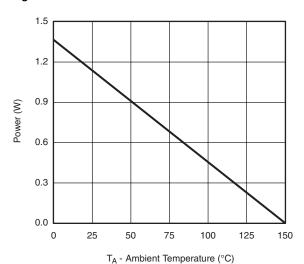


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*





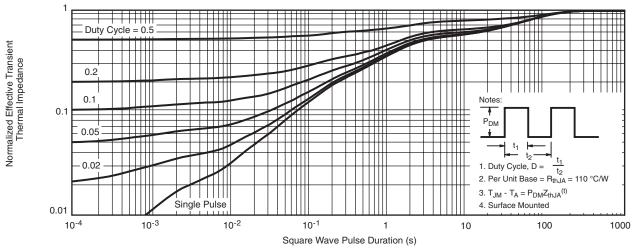
Power Derating, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

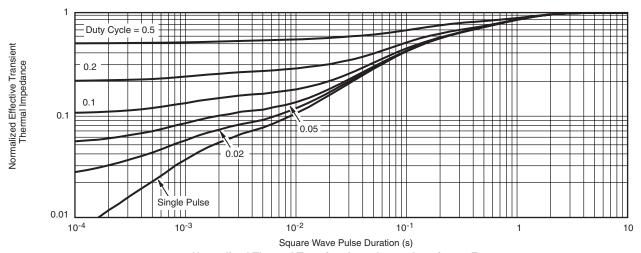
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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